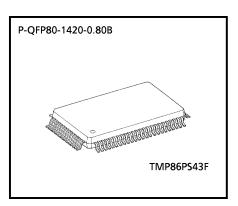
CMOS 8-Bit Microcontroller

TMP86PS43F

The TMP86PS43F is a OTP type MCU which includes 60 Kbytes One-time PROM. It is a pin compatible with a mask ROM product of the TMP86PS43F. Writing the program to built-in PROM, the TMP86PS43F operates as the same way as the TMP86PS43F. Using the Adapter socket, you can write and verify the data for the TMP86PS43F with a general-purpose PROM programmer same as TC571000D/AD.

Product No.	ROM	RAM	Package	Adapter Socket	
TMP86PS43F	60 K × 8 bits	2 K × 8 bits	P-QFP80-1420-0.80B	BM11182	

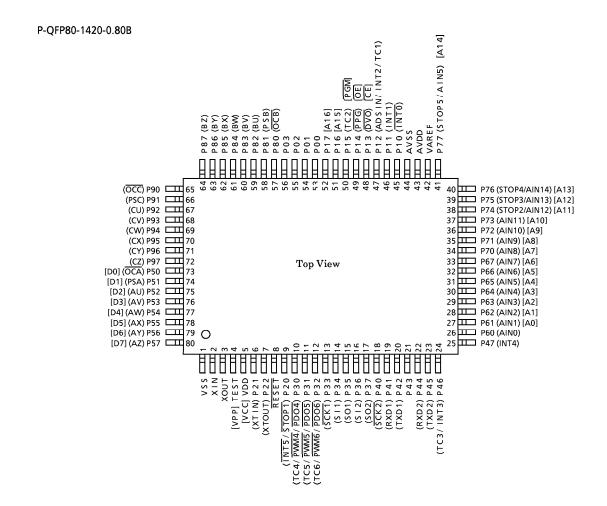


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Pin Assignments (Top View)



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Pin Function

The TMP86PS43 has MCU mode and PROM mode.

(1) MCU mode

In the MCU mode, the TMP86PS43F is a pin compatible with the TMP86PS43F (Mask sure to fix the TEST pin to "L" level).

(2) PROM mode

Pin Name	Input/Output	Functions Pin Name (MCU mod				
A16 to A15			P17 to P16			
A14 to A7	Input	Input of Memory address for program	P77 to P70			
A6 to A0			P67 to P61			
D7 to D0	I/O	Input/Output of Memory data for program	P57 to P50			
CE		Chip enable	P13			
ŌĒ	Input	Output enable	P14			
PGM		Program control	P15			
VPP		+ 12.75 V/5 V (Power supply of program)	TEST			
vcc	Power supply	+ 6.25 V/5 V	VDD			
GND		0 V	VSS			
P11, P21, AVDD		PROM mode setting pin. Fix to "H".				
P00, P10, P20, P22, AVSS, VAREF	1/0	PROM mode setting pin. Fix to "L".				
RESET						
P03 to P01						
P12, P16, P17						
P37 to P30	I/O	Open				
P47 to P40	1/0	Ореп				
P87 to P80						
P97 to P90						
AVDD		5 V				
AVSS	Power supply	0 V (GND)				
VAREF		0 V (GND)				
XIN	Input	5 If 111 it 111 it (65 pm)				
XOUT	Output	Self oscillation with resonator (16 MHz).				

Operation

This section describes the functions and basic operational blocks of TMP86PS43F.

The TMP86PS43F has PROM in place of the mask ROM which is included in the TMP86CS43F. The configuration and function are same as the TMP86CS43F. For TMP86CS43F, however, some functions have been partially changed or deleted. For the function of TMP86PS43F in details, see the section of TMP86CS43F

In addition, TMP86PS43F operates as the single clock mode when releasing reset.

When using the dual clock mode, oscillate a low-frequency clock by SET. XTEN command at the beginning of program.

1. Operating Mode

The TMP86PS43F has MCU mode and PROM mode.

1.1 MCU Mode

The MCU mode is set by fixing the TEST/VPP pin to the "L" level (TEST/VPP pin cannot be used open because it has no built-in pull-down resister).

1.1.1 Program memory

The TMP86PS43F has a 60 Kbyte built-in one time PROM (addresses 1000 to FFFF_H in the MCU mode, addresses 0000 to EFFF_H in the PROM mode).

When using TMP86PS43F for evaluation of TMP86CS43F, the program is written in the program storing area shown in Figure 1-1.

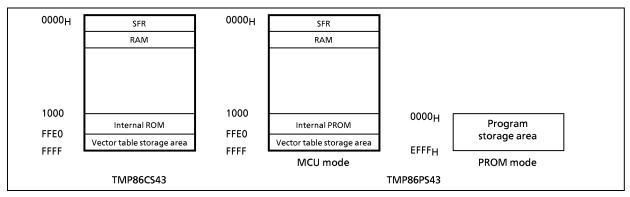


Figure 1-1. Program Memory Area

Note: The area that is not in use should be set data to FF_H, or a general-purpose PROM programmer should be set only in the program memory area to access.

1.1.2 Data Memory

TMP86PS43 has a built-in 2-Kbyte data memory (static RAM).

1.1.3 Input/Output Circuity

(1) Control pins

The control pins of the TMP86PS43 are the same as those the TMP86CS43 except that the TEST pin does not have a built-in pull-down resistor.

(2) I/O ports

The I/O circuities of TMP86PS43 I/O ports are the same as those of TMP86CS43.

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Electrical Characteristics

Absolute Maximum Ratings $(V_{SS} = 0 V)$

Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	V _{DD}		- 0.3 to 6.5	
Program Voltage	V _{PP}		- 0.3 to 13.0] _v
Input Voltage	V _{IN}		- 0.3 to V _{DD} + 0.3]
Output Voltage	V _{OUT}		- 0.3 to V _{DD} + 0.3	
	louth	Except Open-drain	- 3.2	
Output Current (Bor 1 nin)	I _{OUT1}	Except Port P5, P9	3.2	
Output Current (Per 1 pin)	I _{OUT2}	I _{OUT2} Port P5		
	I _{OUT3}	Port P9	30	mA
	Σl _{OUT1}	Except Port P5, P9		
Output Current (Total)	ΣI _{OUT2}	Port P5	60	
	ΣI _{OUT3}	Port P9	1	
Power Dissipation [T _{opr} = 85℃]	PD		250	mW
Soldering Temperature (time)	Tsld		260 (10 s)	
Storage Temperature	Tstg		– 55 to 125	°c
Operating Temperature	Topr		- 40 to 85	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Condition $(V_{SS} = 0 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol	Pins	Condition		Min	Max	Unit	
_			fc = 1 to 16 MHz	Each operation modes	4.5	5.5		
Supply Voltage	V _{DD}		fc = 1 to 8 MHz	Each operation modes	2.7	5.5		
			fs = 32.768 kHz	Each operation modes	2.7	5.5		
			STOP mode		2.0	5.5] v	
	V _{IH1}	Except hysteresis input	$V_{DD} \ge 4.5 \text{ V}$ $V_{DD} < 4.5 \text{ V}$		$V_{DD} \times 0.70$		1	
Input high Level	V _{IH2}	Hysteresis input			$V_{DD} \times 0.75$	V_{DD}		
	V _{IH3}				$V_{DD} \times 0.90$			
	V _{IL1}	Except hysteresis input	V > 4.5.V			$V_{DD} \times 0.30$		
Input low Level	V _{IL2}	Hysteresis input] "	_{DD} ≥ 4.5 V	0	V _{DD} × 0.25		
	V _{IL3}		V _C	_{DD} < 4.5 V		V _{DD} × 0.10	1	
	fc	VIN VOLIT	$V_{DD} = 4.5 \text{ to } 5.5 \text{ V}$		1.0	16.0	MHz	
Clock Frequency	10	XIN, XOUT	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$] '.0	8.0		
	fs	XTIN, XTOUT			30.0	34.0	kHz	

Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

DC Characteristics $(V_{SS} = 0 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol	Pins	Condition	Min	Тур.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis input		_	0.9	_	V
	I _{IN1}	TEST					
Input Current	I _{IN2}	Sink Open Drain, Tri-state port	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	-	_	± 2	μA
	I _{IN3}	STOP, RESET					ĺ
	R _{IN1}	RESET		100	220	450	
Input Resistance	R _{IN2}	Programmable pull up (P6, P7, PA, PB)		40	80	200	kΩ
OSC. Feedback	Rfx	XIN-XOUT		_	1.2	_	140
resistance	Rfxt	XTIN-XTOUT		_	6	_	ΜΩ
Output Leakage	I _{LO1}	Sink Open Drain port	V _{DD} = 5.5 V, V _{OUT} = 5.5 V	_	-	2	
Current	I _{LO2}	Tri-state port	V _{DD} = 5.5 V, V _{OUT} = 5.5 V/0 V	_	-	± 2	μΑ
"H" output Voltage	V _{OH}	Tri-state port	$V_{DD} = 4.5 \text{ V}, I_{OH} = -0.7 \text{ mA}$	4.1	-	_	V
"L" output Voltage	V _{OL3}	Except XOUT, P5, P9	$V_{DD} = 4.5 \text{ V}, I_{OL} = 1.6 \text{ mA}$	_	-	0.4	
#1.# - 1 - 1 C 1	I _{OL1}	Except XOUT, P5, P9	$V_{DD} = 4.5 \text{ V}, V_{OL} = 0.4 \text{ V}$	_	1.6	-	
"L" output Current	I _{OL3}	High current port (P5, P9)	$V_{DD} = 4.5 \text{ V}, V_{OL} = 1.0 \text{ V}$	_	20	_	
Supply Current in			V _{DD} = 5.5 V		15	20] mA
Normal 1, 2 mode			V _{IN} = 5.3 V/0.2 V		13	20] '''A
Supply Current in			fc = 16 MHz	_	9	13	
IDLE 1, 2 mode			fs = 32.768 kHz			13	
Supply Current in	I _{DD}		V _{DD} = 3.0 V	_	30	60	
SLOW 1 mode			$V_{IN} = 2.8 \text{ V}/0.2 \text{ V}$				
Supply Current in			fs = 32.768 kHz	_	15	30	μΑ
SLEEP 0, 1 mode			13 – 32.700 KHZ		'	30]
Supply Current in			$V_{DD} = 5.5 V$	_	0.5	10	
STOP mode			V _{IN} = 5.3 V/0.2 V		0.5	, ,	

Note 1: Typical values show those at Topr = 25°C, $V_{DD} = 5$ V

Note 2: Input current (I_{IN1} , I_{IN3}); The current through resistor is not included, when the input resistor (pull-up or pull-down) is contained.

Note 3: IDD; Except for IREF.

AD Conversion Characteristics

(V_{SS} = 0 V, 4.5 V \leq V_{DD} \leq 5.5 V, Topr = -40 to 85°C)

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Analog Reference Voltage	V _{AREF}		A _{VDD} – 1.0	_	A _{VDD}	
Power Supply Voltage of	A _{VDD}			V_{DD}]
Analog Control Circuit	A _{VSS}			V _{SS}] ,
Analog Reference of Voltage Range (Note 4)	$\triangle V_{AREF}$		3.5	-	V _{DD}] "
Analog Input Voltage	V _{AIN}		V _{SS}	-	V _{AREF}	1
Power Supply Current of Analog Reference Voltage	I _{REF}	$V_{DD} = A_{VDD} = V_{AREF} = 5.5 \text{ V}$ $V_{SS} = AV_{SS} = 0.0 \text{ V}$	-	0.6	1.0	mA
Non linearity Error			_	_	± 2	
Zero Point Error		$V_{DD} = A_{VDD} = 5.0 \text{ V}$	-	_	± 2]
Full Scale Error		$V_{SS} = A_{VSS} = 0.0 \text{ V}$ $V_{AREF} = 5.0 \text{ V}$	_	-	± 2	LSB
Total Error		70321	-	_	± 4	1

- Note 1: The total error includes all errors except a quantization error, and is defined as a maximum deviation from the ideal conversion line.
- Note 2: Conversion time is different in recommended value by power supply voltage.

 About conversion time, please refer to "2.14.2 Register Configuration".
- Note 3: Please use input voltage to AIN input Pin in limit of V_{AREF} V_{SS}.
 - When voltage of range outside is input, conversion value becomes unsettled and gives affect to other channel conversion value.
- Note 4: Analog Reference Voltage Range: $\triangle V_{AREF} = V_{AREF} V_{SS}$

AC Characteristics

 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
		NORMAL 1, 2 mode		-	4	
		IDLE 0, 1, 2 mode	0.25			μS
Machine Cycle Time	tcy	SLOW 1, 2 mode	447.6	_	133.3	μ3
		SLEEP 0, 1, 2 mode	117.6			
High Level Clock Pulse Width	t _{WCH}	For external clock operation (XIN input)				
Low Level Clock Pulse Width	t _{WCL}	fc = 16 MHz		31.25	-	ns
High Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input)	-			
Low Level Clock Pulse Width	t _{WSL}	fs = 32.768 kHz		15.26	_	μ\$

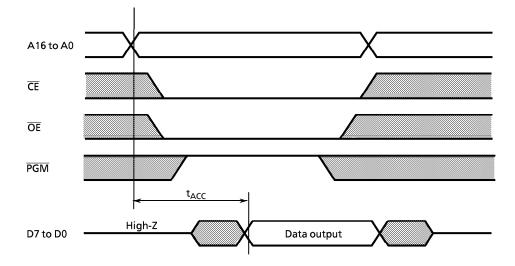
DC Characteristics, AC Characteristics (PROM Mode)

 $(V_{SS} = 0 \text{ V, Topr} = 25 \pm 5^{\circ}\text{C})$

(1) Read operation in PROM mode

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
High level input voltage (TTL)	V _{IH4}		2.2	-	V _{CC}	
Low leve input voltage (TTL)	V _{IL4}		0	-	0.8	v
Power supply	V _{CC}		4.75	5.0	5.25	v
Power supply of program	V _{PP}		4.73	3.0	3.23	
Address access time	t _{ACC}	V _{CC} = 5.0 ± 0.25 V	_	1.5tcyc + 300	-	ns

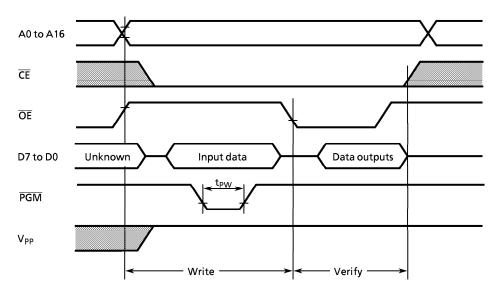
Note: tcyc = 250 ns at 16 MHz



(2) Program operation (High-speed) (Topr = $25 \pm 5^{\circ}$ C)

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
High level input voltage (TTL)	V _{IH4}		2.2	-	V _{CC}	
Low leve input voltage (TTL)	V _{IL4}		0	-	0.8	v
Power supply	V _{CC}		6.0	6.25	6.5	V
Power supply of program	V _{PP}		12.5	12.75	13.0	
Pulse width of initializing program	t _{PW}	V _{CC} = 6.0 V	0.095	0.1	0.105	ms

High-speed program



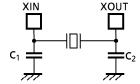
- Note 1: The power supply of V_{PP} (12.75 V) must be set power-on at the same time or the later time for a power supply of V_{CC} and must be clear power-on at the same time or early time for a power supply of V_{CC} .
- Note 2: The pulling up/down device on the condition of $V_{PP} = 12.75 \text{ V } \pm 0.25 \text{ V}$ causes a damage for the device. Do not pull up/down at programming.
- Note 3: Use the recommended adapter (see 1.2.2 (1)) and mode (see 1.2.2 (3) i).

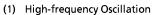
 Using other than the above condition may cause the trouble of the writting.

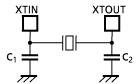
Recommended Oscillating Conditions

 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, Topr = -40 \text{ to } 85^{\circ}\text{C})$

Danamatan	On Alleston	Oscillation	D	D 1.10 '''		Recommended Constant		
Parameter Oscillator		Frequency	quency Recommended Oscillator		C ₁	C ₂		
	16 MHz	MURATA	CSA16.00MXZ040	10 pF	10 pF			
Ulab francisa		0.8411	MURATA	CSA8.00MTZ	30 pF	30 pF		
High-frequency Oscillation	Ceramic Resonator	8 MHz		CST8.00MTW	30 pF (built-in)	30 pF (built-in)		
Oscillation		4.40.8411	MURATA	CSA4.19MG	30 pF	30 pF		
		4.19 MHz		CST4.19MGW	30 pF (built-in)	30 pF (built-in)		
Low-frequency	Crystal Oscillator	32.768 kHz	SII	VT-200	6 pF	6 pF		
Oscillation	Crystal Oscillator	32.700 KHZ	311	V 1-200	брг	ОРГ		







(2) Low-frequency Oscillation

- Note 1: An electrical shield by metal shield plate on the surface of IC package is recommended in order to protect the device from the high electric field stress applied from CRT (Cathodic Ray Tube) for continuous reliable operation.
- Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL; http://www.murata.co.jp/search/index.html